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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

КОЛ ЅАТО

Serial No.: 09/998,467

Filed: November 29, 2001

For: A SEMICONDUCTOR DEVICE

HAVING BUMPS (As Amended)

Art Unit: 2822

Examiner: Monica Lewis

AMENDMENT

FAX COPY RECEIVED

Commissioner for Patents Washington, D.C. 20231

SEP 1 9 2002

TECHNOLOGY CENTER 2800

Dear Sir:

AI

In response to the Office Action dated June 19, 2002, please amend the above-identified application as follows:

IN THE TITLE OF THE INVENTION:

Please delete the title and substitute therefor -- A SEMICONDUCTOR DEVICE HAVING BUMPS --.

IN THE SPECIFICATION:

Page 2, line 6, please delete "SUMMARY OF THE INVENTUION" to --SUMMARY OF THE INVENTION--.

Please replace page 4, last paragraph, with the following rewritten paragraph:

-Figure 7 is a top view of a semiconductor device in one step of a prior art semiconductor device manufacturing process that uses a carrier film;--

Please replace page 5, first full paragraph, with the following rewritten paragraph: